

## HW1 Zhijia Chen

### 1.1

a.

$$\text{Die area} = 2 \text{ cm}^2$$

$$\begin{aligned}\text{Yield} &= \frac{1}{(1 + \text{Defects per unit area} \times \text{Die area})^N} \\ &= \frac{1}{(1 + 0.04 \times 2)^{14}} \\ &= 0.341\end{aligned}$$

b.

Because Phoenix has smaller manufacturing size than BlueDragon and thus its manufacturing is more difficult.

### 1.4

a.

For core running at full power:

$$\begin{aligned}\text{Power}_{dynamic} &= \text{number of cores} \times \text{full power} \\ &= 4 \times 0.5 \text{ W} \\ &= 2 \text{ W} \\ \text{Energy}_{dynamic} &= \text{Power}_{dynamic} \times T \\ &= 2T\end{aligned}$$

Where T is the time required for the phone to finish the task when running at full power.

For core running 1/8 of the time: The workload, capacity and voltage are not changed, so the required dynamic energy remains the same as running at full power, i.e.,

$$\text{Energy}_{dynamic} = 2T$$

The average dynamic power would reduced to 1/8

$$\begin{aligned}\text{Power}_{dynamic} &= 2/8 \\ &= 0.25 \text{ W}\end{aligned}$$

b.

Since the frequency and the voltage are both reduced to 1/8 the entire time,  $\text{Energy}_{dynamic} \propto \text{Capacitive load} \times \text{Voltage}^2$  and  $\text{Power}_{dynamic} \propto \text{Capacitive load} \times \text{Voltage}^2 \times \text{Frequency}$

$$\begin{aligned}
Energy_{dynamic} &= \left(\frac{1}{8}\right)^2 \times 2T \\
&= \frac{1}{64} \times 2T \\
&= \frac{1}{32}T \\
Power_{dynamic} &= \left(\frac{1}{8}\right)^2 \times \frac{1}{8} \times 2 \text{ W} \\
&= \frac{1}{512} \times 2 \text{ W} \\
&= \frac{1}{256} \text{ W}
\end{aligned}$$

**c.**

If voltage reduced to 1/2 and frequency reduced to 1/8:

$$\begin{aligned}
Energy_{dynamic} &= \left(\frac{1}{2}\right)^2 \times 2T \\
&= \frac{1}{4} \times 2T \\
&= \frac{1}{2}T \\
Power_{dynamic} &= \left(\frac{1}{2}\right)^2 \times \frac{1}{8} \times 2 \text{ W} \\
&= \frac{1}{32} \times 2 \text{ W} \\
&= \frac{1}{16} \text{ W}
\end{aligned}$$

**d.**

No idea...

### 1.7

**a.**  $2^5 = 32$

**b.** The clock rate would be  $5 \text{ MHz} \times 1.4^{(2025 - 1978)} \approx 37 \text{ THz}$

**c.** In the year of 2017, the chip has the clock rate at 4200 MHz, and the current rate of increase is 2%, thus the projected performance in 2025 is  $4200 \text{ MHz} \times 1.02^{(2025 - 2017)} \approx 4920 \text{ MHz}$ .

**d.** The Moore's law has ended, the number of transistors on a chip has reached its limit, also the heat dissipation has also becomes a problem, hampering the further increasing of clock rate.

**e.** By current DRAM growth rate, the capacity doubles in 4 years, thus the growth rate is  $2^{0.25} \approx 1.189$ .

**1.9**

For the following question, I suppose that the server being turned off or put in "barely live" state or reduced voltage and frequency are running at 60% of capacity and consuming 90% of the maximum power.

**a.** The saving would be  $0.9 \times 0.6 \times$  maximum operate power, that is, 54% of the maximum operate power.

**b.** The saving would be  $0.9 \times (0.6 - 0.2) \times$  maximum operate power, that is, 36% of the maximum operate power.

**c.** The power saving would be  $1 - (1 - 0.2)^2 \times (1 - 0.4) = 0.616$ , that's 61.6% of the current running power, or  $(0.616 \times 0.9)$  of the maximum power, i.e., 55.44% of the maximum power.

**d.**

The saving would be  $(54\%/2 + 36\%/2)$  of the maximum power, i.e., 45% of the maximum power.

**1.10.**

**a.**

That means the  $MTTF = \frac{10^9}{100} = 10^7$ .

**b.**

$availability = \frac{MTTF}{(MTTF + MTTR)} = \frac{10^7}{(10^7 + 24)} \approx 0.999998$

**c.**

Assume that the lifetimes are exponentially distributed and the failures are independent:

$$\begin{aligned} \text{Failure rate}_{\text{super computer}} &= 1000 \times \frac{1}{MTTF_{\text{processor}}} \\ &= \frac{1000}{10^7} \\ &= 10^{-4} \\ MTTF_{\text{super computer}} &= \frac{1}{\text{Failure rate}_{\text{super computer}}} \\ &= 10000 \text{ hours} \end{aligned}$$

**1.16.**

**a.**

$$\text{speedup} = \frac{1}{0.2 + \frac{0.8}{N}}$$

**b.**

$$\text{speedup} = \frac{1}{0.2 + \frac{0.8}{8} + 8 \times 0.005} = 2.941$$

**c.**

$$\text{speedup} = \frac{1}{0.2 + \frac{0.8}{8} + 3 \times 0.005} = 3.175$$

**d.**

$$\text{speedup} = \frac{1}{0.2 + \frac{0.8}{N} + \log(N) \times 0.005}$$

**e.**

speedup function:  $f(N) = \frac{1}{1-P+\frac{P}{N}+\log(N)\times 0.005}$ , make  $\frac{df(N)}{dN} = 0$ , i.e.,

$$\frac{d\left(\frac{1}{1-P+\frac{P}{N}+\log(N)\times 0.005}\right)}{dN} = 0$$

### A3

Instruction mix for gobmk and mcf:

**Loads:** 28%

**Stores:** 11.5%

**Branches:** 19%

**Jumps:** 1.5%

**ALU operations:** 39.5%

**others:** 0.5%

$$\begin{aligned}\text{effective CPI} &= \sum \text{Instruction category frequency} \times \text{Clock cycles for category} \\ &= 0.28 \times 3.5 + 0.115 \times 2.8 + 0.19 \times (0.6 \times 4 + (1 - 0.6) \times 2) \\ &\quad + 0.015 \times 2.4 + 0.395 \times 1 + 0.005 \times 3 \\ &= 2.356\end{aligned}$$

### A9

**a.**

Yes. For 3 two-address instructions, we can use (00, 01, 10) of the first two bits to represent the 3 instructions and the remaining 12 bits to hold the two addresses. Then the first two bits of all other instructions must be (11). For the 63 one-address instructions, we start it with (11) and use the following 6 bits to present the 63 instructions excluding (11000000), and the last 6 bits to hold the address. And then we start the 45 zero-address instructions with (11000000) and use the remaining 6 bits to represent the 45 instructions.

**b.**

Impossible.